



Product Change Notification

113584 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

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Japan Email: jccb.ijkk@intel.com

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Product Change Notification

Change Notification #: 113584 - 00

**Change Title: Boxed Intel® NUC Kit
DN2820FYKH, Single Pack, Intel®
NUC Board DN2820FYB, 10 Pack,
PCN 113584-00
Product Design
Update Bios to Enhance Thermal
Trip and Security**

Date of Publication: January 21, 2015

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Feb 10, 2015
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Description of Change to the Customer:

Updating BIOS from FY0034 to FY0047 will enhance the unit BIOS security and thermal trip point. . To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate the new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure there is no quality or reliability implication to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS. This change is not expected to cause a change to the Microsoft Windows* operating system's software driver stack.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BOXDN2820FYKH0	933307	H22962-106	H24582-204	H22962-107	H24582-205
BLKDN2820FYB	933308		H24582-204		H24582-205

PCN Revision History:**Date of Revision:**

January 13, 2015

Revision Number:

00

Reason:

Originally Published PCN